## 9FGV0841

## 8-Output Very Low-Power PCIe Gen1-2-3-4 Clock Generator with Zo=100ohms

#### DATASHEET

#### Description

The 9FGV0841 is a member of IDT's SOC-friendly 1.8V very low-power PCIe clock family. It has integrated output terminations providing Zo =  $100\Omega$  for direction connection to  $100\Omega$  transmission lines. The device has 8 output enables for clock management, 2 different spread spectrum levels in addition to spread off, and 2 selectable SMBus addresses.

## **Typical Applications**

PCIe Gen1–4 clock generation for Riser Cards, Storage, Networking, JBOD, Communications, Access Points

## **Output Features**

- 8 100MHz Low-Power (LP) HCSL DIF pairs with Zo =  $100\Omega$
- 1 1.8V LVCMOS REF output with Wake-On-LAN (WOL) support

## **Key Specifications**

- DIF cycle-to-cycle jitter <50ps
- DIF output-to-output skew <50ps
- DIF phase jitter is PCIe Gen1-2-3-4 compliant
- REF phase jitter is <1.5ps RMS</li>

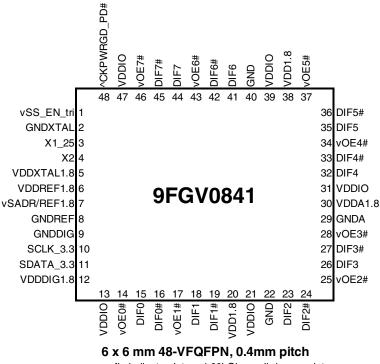
#### Features

- Direct connection to 100Ω transmission lines; saves 32 resistors compared to standard PCIe devices
- 62mW typical power consumption; reduced thermal concerns
- Outputs can optionally be supplied from any voltage between 1.05 and 1.8V; maximum power savings
- OE# pins; support DIF power management
- LP-HCSL differential clock outputs; reduced power and board space
- Programmable slew rate for each output; allows tuning for various line lengths
- Programmable output amplitude; allows tuning for various application environments
- DIF outputs blocked until PLL is locked; clean system start-up
- Selectable 0%, -0.25% or -0.5% spread on DIF outputs; reduces EMI
- External 25MHz crystal; supports tight ppm with 0 ppm synthesis error
- Configuration can be accomplished with strapping pins; SMBus interface not required for device control
- 3.3V tolerant SMBus interface works with legacy controllers
- Selectable SMBus addresses; multiple devices can easily share an SMBus segment
- Space saving 6 x 6 mm 48-VFQFPN; minimal board space

#### vOE(7:0)# REF1.8 XIN/CLKIN\_25 osc DIF7 \_X2 DIF6 DIF5 SS Capable PLL DIF4 DIF3 vSADR vSS\_EN\_tri DIF2 ^CKPWRGD PD# CONTROL DIF1 LOGIC SDATA 3.3 SCLK\_3.3 DIF0

## **Block Diagram**

#### **Pin Configuration**



vv prefix indicates internal 60kOhm pull-down resistor

v prefix indicates internal 120kOhm pull-down resistor

^ prefix indicates internal 120kOhm pull-up resistor

#### **SMBus Address Selection Table**

|                                    | SADR | Address | + Read/Write Bit |
|------------------------------------|------|---------|------------------|
| State of SADR on first application | 0    | 1101000 | Х                |
| of CKPWRGD_PD#                     | 1    | 1101010 | Х                |

#### **Power Management Table**

| CKPWRGD PD# | SMBus  |                               | DIFx    |         | REF               |
|-------------|--------|-------------------------------|---------|---------|-------------------|
|             | OE bit | E bit OEx# True O/P Comp. O/P |         |         |                   |
| 0           | Х      | Х                             | Low     | Low     | Hi-Z <sup>1</sup> |
| 1           | 1      | 0                             | Running | Running | Running           |
| 1           | 0      | 1                             | Low     | Low     | Low               |

1. REF is Hi-Z until the 1st assertion of CKPWRGD\_PD# high. After this, when CKPWRG\_PD# is low, REF is Low.

#### **Power Connections**

| Pin Number |                    |          | Description              |
|------------|--------------------|----------|--------------------------|
| VDD        | VDDIO              | GND      | Description              |
| 5          |                    | 2        | XTAL OSC                 |
| 6          |                    | 8        | REF Power                |
| 12         |                    | 9        | Digital (dirty)<br>Power |
| 20,38      | 13,21,31,39,<br>47 | 22,29,40 | DIF outputs              |
| 30         |                    | 29       | PLL Analog               |

## **Pin Descriptions**

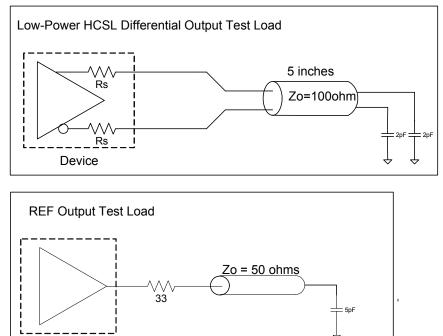
| PIN # | PIN NAME     | TYPE    | DESCRIPTION   |
|-------|--------------|---------|---|
| 4     |              | LATCHED | Latched select input to select spread spectrum amount at initial power up :   |
| 1     | vSS_EN_tri   | IN      | 1 = -0.5% spread, M = -0.25%, 0 = Spread Off                                  |
| 2     | GNDXTAL      | GND     | GND for XTAL  |
| 3     | X1_25        | IN      | Crystal input, Nominally 25.00MHz.  |
| 4     | <br>X2       | OUT     | Crystal output.   |
| 5     | VDDXTAL1.8   | PWR     | Power supply for XTAL, nominal 1.8V   |
| 6     | VDDREF1.8    | PWR     | VDD for REF output. nominal 1.8V.   |
|       |              | LATCHED |   |
| 7     | vSADR/REF1.8 | I/O     | Latch to select SMBus Address/1.8V LVCMOS copy of X1/REFIN pin                |
| 8     | GNDREF       | GND     | Ground pin for the REF outputs.   |
| 9     | GNDDIG       | GND     | Ground pin for digital circuitry  |
| 10    | SCLK_3.3     | IN      | Clock pin of SMBus circuitry, 3.3V tolerant.                                  |
| 11    | SDATA_3.3    | I/O     | Data pin for SMBus circuitry, 3.3V tolerant.                                  |
| 12    | VDDDIG1.8    | PWR     | 1.8V digital power (dirty power)  |
| 13    | VDDIO        | PWR     | Power supply for differential outputs   |
|       |              |         | Active low input for enabling DIF pair 0. This pin has an internal pull-down. |
| 14    | vOE0#        | IN      | 1 = disable outputs, 0 = enable outputs                                       |
| 15    | DIF0         | OUT     | Differential true clock output  |
| 16    | DIF0#        | OUT     | Differential Complementary clock output                                       |
|       |              |         | Active low input for enabling DIF pair 1. This pin has an internal pull-down. |
| 17    | vOE1#        | IN      | 1 = disable outputs, 0 = enable outputs                                       |
| 18    | DIF1         | OUT     | Differential true clock output  |
| 19    | DIF1#        | OUT     | Differential Complementary clock output                                       |
| 20    | VDD1.8       | PWR     | Power supply, nominal 1.8V  |
| 21    | VDDIO        | PWR     | Power supply for differential outputs   |
| 22    | GND          | GND     | Ground pin.   |
| 23    | DIF2         | OUT     | Differential true clock output  |
| 24    | DIF2#        | OUT     | Differential Complementary clock output                                       |
| 27    |              |         | Active low input for enabling DIF pair 2. This pin has an internal pull-down. |
| 25    | vOE2#        | IN      | 1 = disable outputs, 0 = enable outputs                                       |
| 26    | DIF3         | OUT     | Differential true clock output  |
| 27    | DIF3#        | OUT     | Differential Complementary clock output                                       |
| 21    |              |         | Active low input for enabling DIF pair 3. This pin has an internal pull-down. |
| 28    | vOE3#        | IN      | 1 = disable outputs, 0 = enable outputs                                       |
| 29    | GNDA         | GND     | Ground pin for the PLL core.  |
| 30    | VDDA1.8      | PWR     | 1.8V power for the PLL core.  |
| 31    | VDDA1.0      | PWR     | Power supply for differential outputs   |
| 32    | DIF4         | OUT     | Differential true clock output  |
| 33    | DIF4#        | OUT     | Differential Complementary clock output                                       |
|       |              |         | Active low input for enabling DIF pair 4. This pin has an internal pull-down. |
| 34    | vOE4#        | IN      | 1 =disable outputs, 0 = enable outputs  |
| 35    | DIF5         | OUT     | Differential true clock output  |
| 36    | DIF5#        | OUT     | Differential Complementary clock output                                       |
| 50    | ווש ווש #    |         | Active low input for enabling DIF pair 5. This pin has an internal pull-down. |
| 37    | vOE5#        | IN      |   |
| 20    | VDD1.8       | PWR     | 1 =disable outputs, 0 = enable outputs<br>Power supply, nominal 1.8V          |
| 38    |              |         |   |
| 39    | VDDIO        | PWR     | Power supply for differential outputs   |



| PIN # | PIN NAME     | TYPE | DESCRIPTION   |
|-------|--------------|------|---|
| 40    | GND          | GND  | Ground pin.   |
| 41    | DIF6         | OUT  | Differential true clock output  |
| 42    | DIF6#        | OUT  | Differential Complementary clock output                                       |
| 43    | vOE6#        | IN   | Active low input for enabling DIF pair 6. This pin has an internal pull-down. |
| 43    | VOE0#        |      | 1 =disable outputs, 0 = enable outputs  |
| 44    | DIF7         | OUT  | Differential true clock output  |
| 45    | DIF7#        | OUT  | Differential Complementary clock output                                       |
| 46    | vOE7#        | IN   | Active low input for enabling DIF pair 7. This pin has an internal pull-down. |
| 40    | VOE7#        |      | 1 =disable outputs, 0 = enable outputs  |
| 47    | VDDIO        | PWR  | Power supply for differential outputs   |
|       |              |      | Input notifies device to sample latched inputs and start up on first high     |
| 48    | ^CKPWRGD_PD# | IN   | assertion. Low enters Power Down Mode, subsequent high assertions exit        |
|       |              |      | Power Down Mode. This pin has internal pull-up resistor.                      |

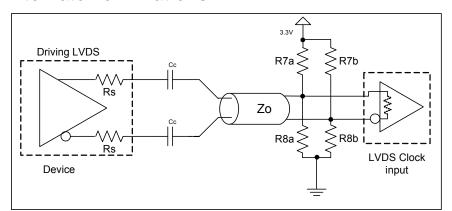
## Pin Descriptions (cont.)

#### **Test Loads**



## Alternate Terminations

**REF** Output



#### **Driving LVDS inputs**

|           | ,<br>,       | Value                          |      |  |  |  |
|-----------|--------------|--------------------------------|------|--|--|--|
|           | Receiver has | Receiver has Receiver does not |      |  |  |  |
| Component | termination  | have termination               | Note |  |  |  |
| R7a, R7b  | 10K ohm      | 140 ohm                        |      |  |  |  |
| R8a, R8b  | 5.6K ohm     | 75 ohm                         |      |  |  |  |
| Cc        | 0.1 uF       | 0.1 uF                         |      |  |  |  |
| Vcm       | 1.2 volts    | 1.2 volts                      |      |  |  |  |

## **Absolute Maximum Ratings**

Stresses above the ratings listed below can cause permanent damage to the 9FGV0841. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

| PARAMETER                 | SYMBOL          | CONDITIONS                | MIN  | TYP | МАХ            | UNITS | NOTES |
|---------------------------|-----------------|---------------------------|------|-----|----------------|-------|-------|
| Supply Voltage            | VDDxx           | Applies to all VDD pins   | -0.5 |     | 2.5            | V     | 1,2   |
| Input Voltage             | V <sub>IN</sub> |                           | -0.5 |     | $V_{DD}$ +0.5V | V     | 1, 3  |
| Input High Voltage, SMBus | VIHSMB          | SMBus clock and data pins |      |     | 3.6V           | V     | 1     |
| Storage Temperature       | Ts              |                           | -65  |     | 150            | С°    | 1     |
| Junction Temperature      | Tj              |                           |      |     | 125            | °C    | 1     |
| Input ESD protection      | ESD prot        | Human Body Model          | 2000 |     |                | V     | 1     |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Operation under these conditions is neither implied nor guaranteed.

<sup>3</sup> Not to exceed 2.5V.

### **Electrical Characteristics–Current Consumption**

TA = T<sub>AMB;</sub> Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

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|--|---------------------|--|-----|--------|-----|-------|-------|
| PARAMETER                                  | SYMBOL              | CONDITIONS   | MIN | TYP    | MAX | UNITS | NOTES |
|  | I <sub>DDAOP</sub>  | VDDA, All outputs active @100MHz                                       |     | 6      | 9   | mA    |       |
| Operating Supply Current                   | I <sub>DDOP</sub>   | All VDD, except VDDA and VDDIO, All outputs active @100MHz             |     | 12     | 16  | mA    |       |
|  | I <sub>DDIOOP</sub> | VDDIO, All outputs active @100MHz                                      |     | 28     | 35  | mA    |       |
| Wake-on-LAN Current                        | I <sub>DDAPD</sub>  | VDDA, DIF outputs off, REF output running                              |     | 0.4    | 1   | mA    | 2     |
| (CKPWRGD_PD# = '0'<br>Byte 3, bit 5 = '1') | I <sub>DDPD</sub>   | All VDD, except VDDA and VDDIO,<br>DIF outputs off, REF output running |     | 5.3    | 8   | mA    | 2     |
| byte 5, bit 5 = 1)                         | IDDIOPD             | VDDIO, DIF outputs off, REF output running                             |     | 0.04   | 0.1 | mA    | 2     |
| Powerdown Current                          | I <sub>DDAPD</sub>  | VDDA, all outputs off  |     | 0.4    | 1   | mA    |       |
| (CKPWRGD_PD# = '0'                         | I <sub>DDPD</sub>   | All VDD, except VDDA and VDDIO, all outputs off                        |     | 0.6    | 1   | mA    |       |
| Byte 3, bit 5 = '0')                       | I <sub>DDIOPD</sub> | VDDIO, all outputs off   |     | 0.0005 | 0.1 | mA    |       |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> This is the current required to have the REF output running in Wake-on-LAN mode (Byte 3, bit 5 = 1)

#### Electrical Characteristics–DIF Output Duty Cycle, Jitter, and Skew Characteristics

TA = T<sub>AMB</sub>; Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER              | SYMBOL                | CONDITIONS                        | MIN | TYP | MAX | UNITS | NOTES |
|------------------------|-----------------------|-----------------------------------|-----|-----|-----|-------|-------|
| Duty Cycle             | t <sub>DC</sub>       | Measured differentially, PLL Mode | 45  | 50  | 55  | %     | 1,2   |
| Skew, Output to Output | t <sub>sk3</sub>      | Averaging on, $V_T = 50\%$        |     | 43  | 50  | ps    | 1,2   |
| Jitter, Cycle to cycle | t <sub>jcyc-cyc</sub> |                                   |     | 14  | 50  | ps    | 1,2   |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Measured from differential waveform

# Electrical Characteristics–Input/Supply/Common Parameters–Normal Operating Conditions

TA = T<sub>AMB:</sub> Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER                    | SYMBOL              | CONDITIONS  | MIN                   | TYP          | MAX            | UNITS  | NOTES |
|------------------------------|---------------------|---|-----------------------|--------------|----------------|--------|-------|
| Supply Voltage               | VDDxx               | Supply voltage for core, analog and single-ended<br>LVCMOS outputs  | 1.7                   | 1.8          | 1.9            | V      |       |
| Output Supply Voltage        | VDDIO               | Supply voltage for differential Low Power Outputs   | 0.9975                | 1.05-1.8     | 1.9            | V      |       |
| Ambient Operating            | T <sub>AMB</sub>    | Commercial range  | 0                     | 25           | 70             | °C     |       |
| Temperature                  |                     | Industrial range  | -40                   | 25           | 85             | °C     |       |
| Input High Voltage           | V <sub>IH</sub>     | Single-ended inputs, except SMBus   | $0.75 V_{DD}$         |              | $V_{DD} + 0.3$ | V      |       |
| Input Mid Voltage            | VIM                 | Single-ended tri-level inputs ('_tri' suffix)   | $0.4 V_{DD}$          | $0.5 V_{DD}$ | $0.6 V_{DD}$   | V      |       |
| Input Low Voltage            | V <sub>IL</sub>     | Single-ended inputs, except SMBus   | -0.3                  |              | $0.25 V_{DD}$  | V      |       |
| Output High Voltage          | V <sub>IH</sub>     | Single-ended outputs, except SMBus. I <sub>OH</sub> = -2mA  | V <sub>DD</sub> -0.45 |              |                | V      |       |
| Output Low Voltage           | VIL                 | Single-ended outputs, except SMBus. I <sub>OL</sub> = -2mA  |                       |              | 0.45           | V      |       |
|                              | I <sub>IN</sub>     | Single-ended inputs, $V_{IN} = GND$ , $V_{IN} = VDD$  | -5                    |              | 5              | uA     |       |
| Input Current                | I <sub>INP</sub>    | Single-ended inputs<br>$V_{IN} = 0 V$ ; Inputs with internal pull-up resistors<br>$V_{IN} = VDD$ ; Inputs with internal pull-down resistors | -200                  |              | 200            | uA     |       |
| Input Frequency              | F <sub>in</sub>     | XTAL, or X1 input   | 23                    | 25           | 27             | MHz    |       |
| Pin Inductance               | L <sub>pin</sub>    |   |                       |              | 7              | nH     | 1     |
| Osnasitanas                  | C <sub>IN</sub>     | Logic Inputs, except DIF_IN   | 1.5                   |              | 5              | pF     | 1     |
| Capacitance                  | C <sub>OUT</sub>    | Output pin capacitance  |                       |              | 6              | рF     | 1     |
| Clk Stabilization            | T <sub>STAB</sub>   | From V <sub>DD</sub> Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock                                       |                       | 0.6          | 1.8            | ms     | 1,2   |
| SS Modulation Frequency      | f <sub>MOD</sub>    | Allowable Frequency<br>(Triangular Modulation)  | 30                    | 31.6         | 33             | kHz    | 1     |
| OE# Latency                  | t <sub>LATOE#</sub> | DIF start after OE# assertion<br>DIF stop after OE# deassertion   | 1                     | 3            | 3              | clocks | 1,3   |
| Tdrive_PD#                   | t <sub>DRVPD</sub>  | DIF output enable after<br>PD# de-assertion   |                       | 20           | 300            | us     | 1,3   |
| Tfall                        | t <sub>F</sub>      | Fall time of single-ended control inputs  |                       |              | 5              | ns     | 2     |
| Trise                        | t <sub>R</sub>      | Rise time of single-ended control inputs  |                       |              | 5              | ns     | 2     |
| SMBus Input Low Voltage      | VILSMB              | $V_{DDSMB}$ = 3.3V, see note 4 for $V_{DDSMB}$ < 3.3V   |                       |              | 0.6            | V      |       |
| SMBus Input High Voltage     | VIHSMB              | $V_{DDSMB} = 3.3V$ , see note 5 for $V_{DDSMB} < 3.3V$  | 2.1                   |              | 3.6            | V      | 4     |
| SMBus Output Low Voltage     | V <sub>OLSMB</sub>  | @ I <sub>PULLUP</sub>   |                       |              | 0.4            | V      |       |
| SMBus Sink Current           | I <sub>PULLUP</sub> | @ V <sub>OL</sub>   | 4                     |              |                | mA     |       |
| Nominal Bus Voltage          | V <sub>DDSMB</sub>  |   | 1.7                   |              | 3.6            | V      |       |
| SCLK/SDATA Rise Time         | t <sub>RSMB</sub>   | (Max VIL - 0.15) to (Min VIH + 0.15)  |                       |              | 1000           | ns     | 1     |
| SCLK/SDATA Fall Time         | t <sub>FSMB</sub>   | (Min VIH + 0.15) to (Max VIL - 0.15)  |                       |              | 300            | ns     | 1     |
| SMBus Operating<br>Frequency | f <sub>MAXSMB</sub> | Maximum SMBus operating frequency   |                       |              | 400            | kHz    | 1     |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

 $^{\rm 2}$  Control input must be monotonic from 20% to 80% of input swing.

 $^3$  Time from deassertion until outputs are >200 mV

 $^4$  For V\_{DDSMB} < 3.3V, V\_{IHSMB} >= 0.65 x V\_{DDSMB}

#### **Electrical Characteristics–DIF Low Power HCSL Outputs**

TA = T<sub>AMB</sub>; Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER              | SYMBOL            | CONDITIONS   | MIN  | TYP  | MAX  | UNITS | NOTES |
|------------------------|-------------------|--|------|------|------|-------|-------|
| Slew rate              | Trf               | Scope averaging on fast setting  | 1.6  | 2.3  | 3.5  | V/ns  | 1,2,3 |
| Siew fale              | ITI               | Scope averaging on slow setting  | 1.3  | 1.9  | 2.9  | V/ns  | 1,2,3 |
| Slew rate matching     | ∆Trf              | Slew rate matching, Scope averaging on   |      | 7    | 20   | %     | 1,2,4 |
| Voltage High           | V <sub>HIGH</sub> | Statistical measurement on single-ended signal<br>using oscilloscope math function. (Scope | 660  | 784  | 850  | mV    | 7     |
| Voltage Low            | V <sub>LOW</sub>  | averaging on)  | -150 | -33  | 150  | IIIV  | 7     |
| Max Voltage            | Vmax              | Measurement on single ended signal using   |      | 816  | 1150 | mV    | 7     |
| Min Voltage            | Vmin              | absolute value. (Scope averaging off)  | -300 | -42  |      | mv    | 7     |
| Vswing                 | Vswing            | Scope averaging off  | 300  | 1634 |      | mV    | 1,2,7 |
| Crossing Voltage (abs) | Vcross_abs        | Scope averaging off  | 250  | 427  | 550  | mV    | 1,5,7 |
| Crossing Voltage (var) | ∆-Vcross          | Scope averaging off  |      | 12   | 140  | mV    | 1,6,7 |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Measured from differential waveform

<sup>3</sup> Slew rate is measured through the Vswing voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V.

<sup>4</sup> Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations.

<sup>5</sup> Vcross is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

<sup>6</sup> The total variation of all Vcross measurements in any particular system. Note that this is a subset of Vcross\_min/max (Vcross absolute) allowed. The intent is to limit Vcross induced modulation by setting  $\Delta$ -Vcross to be smaller than Vcross absolute.

<sup>7</sup> At default SMBus amplitude settings.

## Electrical Characteristics–Filtered Phase Jitter Parameters - PCIe Common Clocked (CC) Architectures

T<sub>AMB</sub> = over the specified operating range. Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| SYMBOL                    | PARAMETER                 | CONDITIONS   | MIN | TYP  | MAX  | Specification<br>Limit | UNITS       | NOTES   |
|---------------------------|---------------------------|--|-----|------|------|------------------------|-------------|---------|
| t <sub>jphPCleG1-CC</sub> |                           | PCIe Gen 1   | 21  | 25   | 35   | 86                     | ps (p-p)    | 1, 2, 3 |
|                           |                           | PCIe Gen 2 Low Band<br>10kHz < f < 1.5MHz<br>(PLL BW of 5-16MHz, 8-16MHz, CDR = 5MHz)            | 0.9 | 0.9  | 1.1  | 3                      | ps<br>(rms) | 1, 2    |
| IjphPCleG2-CC             | Phase Jitter,<br>PLL Mode | PCIe Gen 2 High Band<br>1.5MHz < f < Nyquist (50MHz)<br>(PLL BW of 5-16MHz, 8-16MHz, CDR = 5MHz) | 1.5 | 1.6  | 1.9  | 3.1                    | ps<br>(rms) | 1, 2    |
| t <sub>jphPCleG3-CC</sub> |                           | PCIe Gen 3<br>(PLL BW of 2-4MHz, 2-5MHz, CDR = 10MHz)  | 0.3 | 0.37 | 0.44 | 1                      | ps<br>(rms) | 1, 2    |
| t <sub>jphPCleG4-CC</sub> |                           | PCIe Gen 4<br>(PLL BW of 2-4MHz, 2-5MHz, CDR = 10MHz)  | 0.3 | 0.37 | 0.44 | 0.5                    | ps<br>(rms) | 1, 2    |

Notes on PCIe Filtered Phase Jitter Table

<sup>1</sup> Applies to all differential outputs, guaranteed by design and characterization.

<sup>2</sup> Calculated from Intel-supplied Clock Jitter Tool, with spread on and off.

<sup>3</sup> Sample size of at least 100K cycles. This figure extrapolates to 108ps pk-pk at 1M cycles for a BER of 1<sup>-12</sup>.

#### **Electrical Characteristics-REF**

TA = T<sub>AMB;</sub> Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER                  | SYMBOL                | CONDITIONS                        | MIN | TYP    | MAX  | UNITS       | Notes |
|----------------------------|-----------------------|-----------------------------------|-----|--------|------|-------------|-------|
| Long Accuracy              | ppm                   | see Tperiod min-max values        |     | 0      |      | ppm         | 1,2   |
| Clock period               | T <sub>period</sub>   | 25 MHz output                     |     | 40     |      | ns          | 2     |
| Rise/Fall Slew Rate        | t <sub>rf1</sub>      | Byte 3 = 1F, 20% to 80% of VDDREF | 0.6 | 1      | 1.6  | V/ns        | 1     |
| <b>Rise/Fall Slew Rate</b> | t <sub>rf1</sub>      | Byte 3 = 5F, 20% to 80% of VDDREF | 0.9 | 1.4    | 2.2  | V/ns        | 1,3   |
| <b>Rise/Fall Slew Rate</b> | t <sub>rf1</sub>      | Byte 3 = 9F, 20% to 80% of VDDREF | 1.1 | 1.7    | 2.7  | V/ns        | 1     |
| <b>Rise/Fall Slew Rate</b> | t <sub>rf1</sub>      | Byte 3 = DF, 20% to 80% of VDDREF | 1.1 | 1.8    | 2.9  | V/ns        | 1     |
| Duty Cycle                 | d <sub>t1X</sub>      | $V_T = VDD/2 V$                   | 45  | 49.1   | 55   | %           | 1,4   |
| Duty Cycle Distortion      | d <sub>tcd</sub>      | $V_T = VDD/2 V$                   | 0   | 2      | 4    | %           | 1,5   |
| Jitter, cycle to cycle     | t <sub>icyc-cyc</sub> | $V_T = VDD/2 V$                   |     | 19.1   | 250  | ps          | 1,4   |
| Noise floor                | t <sub>jdBc1k</sub>   | 1kHz offset                       |     | -129.8 | -105 | dBc         | 1,4   |
| Noise floor                | t <sub>jdBc10k</sub>  | 10kHz offset to Nyquist           |     | -143.6 | -115 | dBc         | 1,4   |
| Jitter, phase              | t <sub>jphREF</sub>   | 12kHz to 5MHz                     |     | 0.63   | 1.5  | ps<br>(rms) | 1,4   |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REF is trimmed to 25.00 MHz

<sup>3</sup> Default SMBus Value

<sup>4</sup> When driven by a crystal.

<sup>5</sup> When driven by an external oscillator via the X1 pin, X2 should be floating.

#### **Clock Periods–Differential Outputs with Spread Spectrum Disabled**

|         |              |                              |                                      | Ме                                   | asurement W                | indow                                |                                      |                              |       |       |
|---------|--------------|------------------------------|--------------------------------------|--------------------------------------|----------------------------|--------------------------------------|--------------------------------------|------------------------------|-------|-------|
|         | Center       | 1 Clock                      | 1us                                  | 0.1s                                 | 0.1s                       | 0.1s                                 | 1us                                  | 1 Clock                      |       |       |
| SSC OFF | Freq.<br>MHz | -c2c jitter<br>AbsPer<br>Min | -SSC<br>Short-Term<br>Average<br>Min | - ppm<br>Long-Term<br>Average<br>Min | 0 ppm<br>Period<br>Nominal | + ppm<br>Long-Term<br>Average<br>Max | +SSC<br>Short-Term<br>Average<br>Max | +c2c jitter<br>AbsPer<br>Max | Units | Notes |
| DIF     | 100.00       | 9.94900                      |                                      | 9.99900                              | 10.00000                   | 10.00100                             |                                      | 10.05100                     | ns    | 1,2   |

#### Clock Periods–Differential Outputs with Spread Spectrum Enabled

|        |              |                              |                                      | Ме                                   | easurement W               | indow                                |                                      |                              |       |       |
|--------|--------------|------------------------------|--------------------------------------|--------------------------------------|----------------------------|--------------------------------------|--------------------------------------|------------------------------|-------|-------|
|        | Center       | 1 Clock                      | 1us                                  | 0.1s                                 | 0.1s                       | 0.1s                                 | 1us                                  | 1 Clock                      |       |       |
| SSC ON | Freq.<br>MHz | -c2c jitter<br>AbsPer<br>Min | -SSC<br>Short-Term<br>Average<br>Min | - ppm<br>Long-Term<br>Average<br>Min | 0 ppm<br>Period<br>Nominal | + ppm<br>Long-Term<br>Average<br>Max | +SSC<br>Short-Term<br>Average<br>Max | +c2c jitter<br>AbsPer<br>Max | Units | Notes |
| DIF    | 99.75        | 9.94906                      | 9.99906                              | 10.02406                             | 10.02506                   | 10.02607                             | 10.05107                             | 10.10107                     | ns    | 1,2   |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REF is trimmed to 25.00 MHz

## **General SMBus Serial Interface Information**

#### How to Write

- Controller (host) sends a start bit
- Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) sends the byte count = X
- IDT clock will acknowledge
- Controller (host) starts sending Byte N through Byte N+X-1
- IDT clock will acknowledge each byte one at a time
- Controller (host) sends a stop bit

|              | Index Blo  | ock \  | Write Operation      |
|--------------|------------|--------|----------------------|
| Controller ( | Host)      |        | IDT (Slave/Receiver) |
| Т            | starT bit  |        |                      |
| Slave A      | Address    |        |                      |
| WR           | WRite      |        |                      |
|              |            |        | ACK                  |
| Beginning    | g Byte = N |        |                      |
|              |            |        | ACK                  |
| Data Byte    | Count = X  |        |                      |
|              |            |        | ACK                  |
| Beginnin     | g Byte N   |        |                      |
|              |            |        | ACK                  |
| 0            |            | ×      |                      |
| 0            |            | X Byte | 0                    |
| 0            |            | e      | 0                    |
|              |            |        | 0                    |
| Byte N       | + X - 1    |        |                      |
|              |            |        | ACK                  |
| Р            | stoP bit   |        |                      |

Note: SMBus address is latched on SADR pin.

#### How to Read

- Controller (host) will send a start bit
- Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) will send a separate start bit
- Controller (host) sends the read address
- IDT clock will acknowledge
- IDT clock will send the data byte count = X
- IDT clock sends Byte N+X-1
- IDT clock sends Byte 0 through Byte X (if X<sub>(H)</sub> was written to Byte 8)
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

|     | Index Block R   | Read C | Operation            |
|-----|-----------------|--------|----------------------|
| Co  | ntroller (Host) |        | IDT (Slave/Receiver) |
| Т   | starT bit       |        |                      |
| S   | lave Address    |        |                      |
| WR  | WRite           | _      |                      |
|     |                 |        | ACK                  |
| Beg | inning Byte = N |        |                      |
|     |                 |        | ACK                  |
| RT  | Repeat starT    |        |                      |
| S   | lave Address    |        |                      |
| RD  | ReaD            |        |                      |
|     |                 |        | ACK                  |
|     |                 |        |                      |
|     |                 |        | Data Byte Count=X    |
|     | ACK             |        |                      |
|     |                 |        | Beginning Byte N     |
|     | ACK             |        |                      |
|     |                 | e<br>E | 0                    |
|     | 0               | X Byte | 0                    |
|     | 0               | ×      | 0                    |
|     | 0               |        |                      |
|     | 1               |        | Byte N + X - 1       |
| Ν   | Not acknowledge |        |                      |
| Р   | stoP bit        |        |                      |

#### SMBus Table: Output Enable Register <sup>1</sup>

| Byte 0 | Name    | Control Function | Туре | 0       | 1       | Default |
|--------|---------|------------------|------|---------|---------|---------|
| Bit 7  | DIF OE7 | Output Enable    | RW   | Low/Low | Enabled | 1       |
| Bit 6  | DIF OE6 | Output Enable    | RW   | Low/Low | Enabled | 1       |
| Bit 5  | DIF OE5 | Output Enable    | RW   | Low/Low | Enabled | 1       |
| Bit 4  | DIF OE4 | Output Enable    | RW   | Low/Low | Enabled | 1       |
| Bit 3  | DIF OE3 | Output Enable    | RW   | Low/Low | Enabled | 1       |
| Bit 2  | DIF OE2 | Output Enable    | RW   | Low/Low | Enabled | 1       |
| Bit 1  | DIF OE1 | Output Enable    | RW   | Low/Low | Enabled | 1       |
| Bit 0  | DIF OE0 | Output Enable    | RW   | Low/Low | Enabled | 1       |

1. A low on these bits will override the OE# pin and force the differential output Low/Low

#### SMBus Table: SS Readback and Control Register

| Byte 1 | Name         | Control Function            | Туре            | 0                                      | 1                                       | Default |
|--------|--------------|-----------------------------|-----------------|--|---|---------|
| Bit 7  | SSENRB1      | SS Enable Readback Bit1     | R               | 00' for SS_EN_tri =                    | 0, '01' for SS_EN_tri                   | Latch   |
| Bit 6  | SSENRB1      | SS Enable Readback Bit0     | R               | = 'M', '11 for S                       | S_EN_tri = '1'                          | Latch   |
| Bit 5  | SSEN_SWCNTRL | Enable SW control of SS     | RW              | Values in B1[7:6]<br>control SS amount | Values in B1[4:3]<br>control SS amount. | 0       |
| Bit 4  | SSENSW1      | SS Enable Software Ctl Bit1 | RW <sup>1</sup> | 00' = SS Off, '0'                      | 1' = -0.25% SS,                         | 0       |
| Bit 3  | SSENSW0      | SS Enable Software Ctl Bit0 | RW <sup>1</sup> | '10' = Reserved                        | , '11'= -0.5% SS                        | 0       |
| Bit 2  |              | Reserved                    |                 |  |   | 1       |
| Bit 1  | AMPLITUDE 1  | Controls Output Amplitude   | RW              | 00 = 0.6V                              | 01 = 0.7V                               | 1       |
| Bit 0  | AMPLITUDE 0  |                             | RW              | 10= 0.8V                               | 11 = 0.9V                               | 0       |

1. B1[5] must be set to a 1 for these bits to have any effect on the part.

#### SMBus Table: DIF Slew Rate Control Register

| Byte 2 | Name             | Control Function         | Туре | 0            | 1            | Default |
|--------|------------------|--------------------------|------|--------------|--------------|---------|
| Bit 7  | SLEWRATESEL DIF7 | Adjust Slew Rate of DIF7 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 6  | SLEWRATESEL DIF6 | Adjust Slew Rate of DIF6 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 5  | SLEWRATESEL DIF5 | Adjust Slew Rate of DIF5 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 4  | SLEWRATESEL DIF4 | Adjust Slew Rate of DIF4 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 3  | SLEWRATESEL DIF3 | Adjust Slew Rate of DIF3 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 2  | SLEWRATESEL DIF2 | Adjust Slew Rate of DIF2 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 1  | SLEWRATESEL DIF1 | Adjust Slew Rate of DIF1 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 0  | SLEWRATESEL DIF0 | Adjust Slew Rate of DIF0 | RW   | Slow Setting | Fast Setting | 1       |

#### SMBus Table: Nominal Vhigh Amplitude Control/ REF Control Register

| Byte 3                    | Name                    | Control Function           | Туре | 0                   | 1                 | Default |
|---------------------------|-------------------------|----------------------------|------|---------------------|-------------------|---------|
| Bit 7                     | REF                     | Slew Rate Control          | RW   | 00 = Slowest        | 01 = Slow         | 0       |
| Bit 6                     | I LI                    |                            | RW   | 10 = Fast           | 11 = Faster       | 1       |
| Bit 5 REF Power Down Func | REE Power Down Eurotion | Wake-on-Lan Enable for REF | RW   | REF does not run in | REF runs in Power | 0       |
|                           |                         |                            | 1    | Power Down          | Down              |         |
| Bit 4                     | REF OE                  | REF Output Enable          | RW   | Low                 | Enabled           | 1       |
| Bit 3                     |                         | Reserved                   |      |                     |                   | 1       |
| Bit 2                     | Reserved                |                            |      |                     |                   |         |
| Bit 1                     | Reserved                |                            |      |                     |                   | 1       |
| Bit 0                     |                         | Reserved                   |      |                     |                   | 1       |

#### Byte 4 is Reserved

| Byte 5 | Name | Control Function | Туре | 0            | 1          | Default |  |
|--------|------|------------------|------|--------------|------------|---------|--|
| Bit 7  | RID3 |                  | R    |              | 0          |         |  |
| Bit 6  | RID2 | Revision ID      | R    | A rov-       | 0          |         |  |
| Bit 5  | RID1 | Revision         | R    | A rev = 0000 |            | 0       |  |
| Bit 4  | RID0 |                  | R    |              | 0          |         |  |
| Bit 3  | VID3 |                  | R    |              |            |         |  |
| Bit 2  | VID2 | VENDOR ID        | R    | 0001         | 0001 = IDT |         |  |
| Bit 1  | VID1 | VENDORID         | R    | 0001 – 101   |            | 0       |  |
| Bit 0  | VID0 |                  | R    |              |            | 1       |  |

#### SMBus Table: Revision and Vendor ID Register

#### SMBus Table: Device Type/Device ID

| Byte 6 | Name         | Control Function | Туре | 0                           | 1            | Default |
|--------|--------------|------------------|------|-----------------------------|--------------|---------|
| Bit 7  | Device Type1 |                  | R    | 00 = FGx, 01 = DBx ZDB/FOB, |              | 0       |
| Bit 6  | Device Type0 | Device Type      | R    | 10 = DMx, 11= DBx FOB       |              | 0       |
| Bit 5  | Device ID5   |                  | R    |                             |              | 0       |
| Bit 4  | Device ID4   |                  | R    |                             |              | 0       |
| Bit 3  | Device ID3   | Device ID        | R    | 001000 bina                 | ny or 08 boy | 1       |
| Bit 2  | Device ID2   | Device ID        | R    |                             | IY OF US HEX | 0       |
| Bit 1  | Device ID1   |                  | R    |                             |              | 0       |
| Bit 0  | Device ID0   | ]                | R    |                             |              | 0       |

#### SMBus Table: Byte Count Register

| Byte 7 | Name     | Control Function       | Туре | 0                      | 1                     | Default |  |
|--------|----------|------------------------|------|------------------------|-----------------------|---------|--|
| Bit 7  |          | Reserved               |      |                        |                       | 0       |  |
| Bit 6  | Reserved |                        |      |                        |                       |         |  |
| Bit 5  | Reserved |                        |      |                        |                       |         |  |
| Bit 4  | BC4      |                        | RW   |                        |                       | 0       |  |
| Bit 3  | BC3      |                        | RW   | Writing to this regist | er will configure how | 1       |  |
| Bit 2  | BC2      | Byte Count Programming | RW   | many bytes will be r   | ead back, default is  | 0       |  |
| Bit 1  | BC1      |                        | RW   | = 8 b                  | ytes.                 | 0       |  |
| Bit 0  | BC0      |                        | RW   |                        |                       | 0       |  |

## **Recommended Crystal Characteristics (3225 package)**

|   |             |         | 1     |
|---|-------------|---------|-------|
| PARAMETER   | VALUE       | UNITS   | NOTES |
| Frequency   | 25          | MHz     | 1     |
| Resonance Mode  | Fundamental | -       | 1     |
| Frequency Tolerance @ 25°C  | ±20         | PPM Max | 1     |
| Frequency Stability, ref @ 25°C Over<br>Operating Temperature Range | ±20         | PPM Max | 1     |
| Temperature Range (commercial)                                      | 0~70        | °C      | 1     |
| Temperature Range (industrial)                                      | -40~85      | О°      | 2     |
| Equivalent Series Resistance (ESR)                                  | 50          | Ω Max   | 1     |
| Shunt Capacitance (C <sub>O</sub> )                                 | 7           | pF Max  | 1     |
| Load Capacitance (C <sub>L</sub> )                                  | 8           | pF Max  | 1     |
| Drive Level   | 0.3         | mW Max  | 1     |
| Aging per year  | ±5          | PPM Max | 1     |
|   |             |         |       |

#### Notes:

1. FOX 603-25-150.

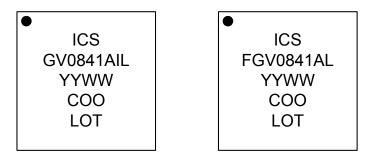
2. For I-temp, FOX 603-25-261.

## **Thermal Characteristics**

| PARAMETER          | SYMBOL            | CONDITIONS                      | PKG   | TYP. | UNITS | NOTES |
|--------------------|-------------------|---------------------------------|-------|------|-------|-------|
| Thermal Resistance | $\theta_{\rm JC}$ | Junction to Case                | NDG48 | 33   | °C/W  | 1     |
|                    | $\theta_{Jb}$     | Junction to Base                |       | 2.1  | °C/W  | 1     |
|                    | θ <sub>JA0</sub>  | Junction to Air, still air      |       | 37   | °C/W  | 1     |
|                    | $\theta_{JA1}$    | Junction to Air, 1 m/s air flow |       | 30   | °C/W  | 1     |
|                    | $\theta_{JA3}$    | Junction to Air, 3 m/s air flow |       | 27   | °C/W  | 1     |
|                    | $\theta_{JA5}$    | Junction to Air, 5 m/s air flow |       | 26   | °C/W  | 1     |

<sup>1</sup>ePad soldered to board

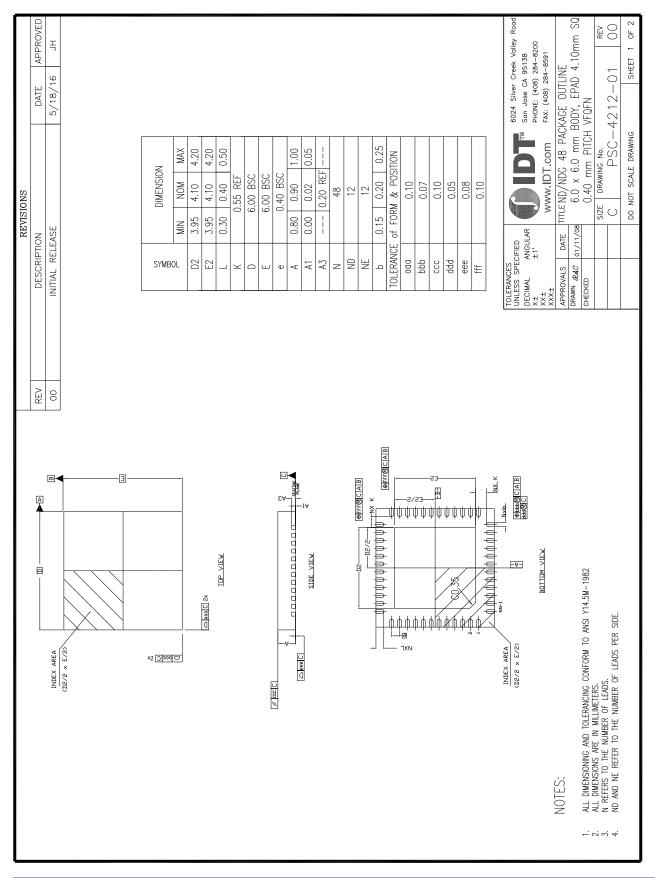
## **Marking Diagrams**



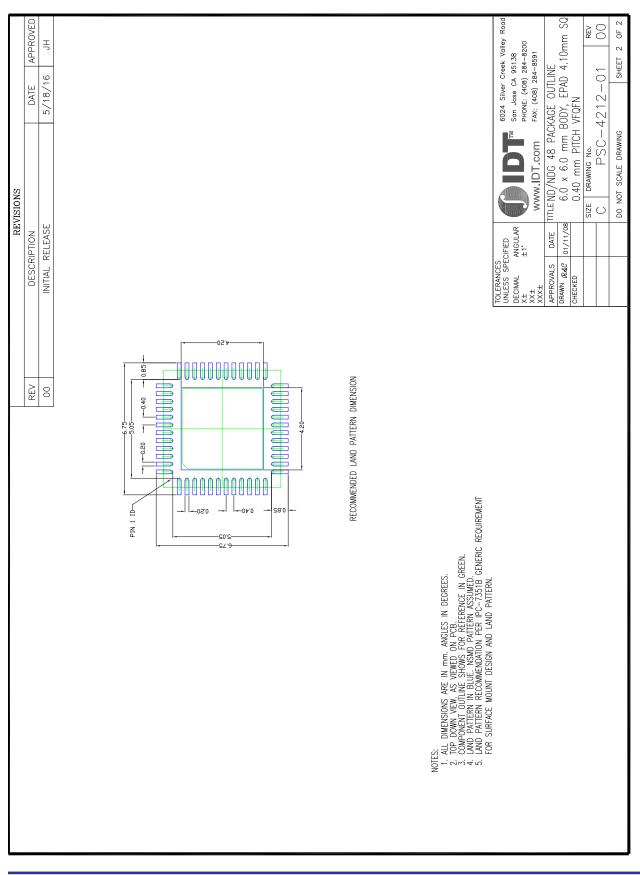
Notes:

- 1. Line 2 is the truncated part number.
- 2. "L" denotes RoHS compliant package.
- 3. "I" denotes industrial temperature grade.
- 4. "YYWW" is the last two digits of the year and week that the part was assembled.
- 5. "COO" denotes country of origin.
- 6. "LOT" is the lot number.

## Package Outline and Dimensions (6 x 6 mm 48-VFQFPN)



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#### Package Outline and Dimensions (6 x 6 mm 48-VFQFPN), cont.

## **Ordering Information**

| Part / Order Number | Shipping Packaging | Package       | Temperature   |  |
|---------------------|--------------------|---------------|---------------|--|
| 9FGV0841AKLF        | Trays              | 48-pin VFQFPN | 0 to +70° C   |  |
| 9FGV0841AKLFT       | Tape and Reel      | 48-pin VFQFPN | 0 to +70° C   |  |
| 9FGV0841AKILF       | Trays              | 48-pin VFQFPN | -40 to +85° C |  |
| 9FGV0841AKLIFT      | Tape and Reel      | 48-pin VFQFPN | -40 to +85° C |  |

"LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant. "A" is the device revision designator (will not correlate with the datasheet revision).

#### **Revision History**

| Rev. | Issue Date | Initiator | Description   | Page # |
|------|------------|-----------|---|--------|
| G    | 11/12/2015 | RDW       | 1. Updated POD diagram.   | 14     |
| Н    | 10/18/2016 | RDW       | Removed IDT crystal part number   |        |
| J    | 6/26/2017  | RG        | Updated front page Gendes to reflect the PCIe Gen4 updates.<br>Updated Electrical Characteristics - Filtered Phase Jitter Parameters -<br>PCIe Common Clocked (CC) Architectures and added PCIe Gen4 Data | 1,7    |



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